

Global Semiconductor Assembly & Packaging Equipment Market 2024 by Manufacturers, Regions, Type and Application, Forecast to 2030

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Abstracts

According to our (Global Info Research) latest study, the global Semiconductor Assembly & Packaging Equipment market size was valued at USD million in 2023 and is forecast to a readjusted size of USD million by 2030 with a CAGR of % during review period.

Semiconductor packaging and assembly equipment is used for an integrated chip to function, it needs to be connected to the package or directly to the printed circuit. This involves wire bonding, die-bonding, and dicing. Also, it is a back end process of chip formation. Semiconductor chip assembly is also a key component of the semiconductor supply chain.

According to our Semiconductor Research Center, in 2022, the global semiconductor equipment was valued at US\$ 109 billion. China mainland, China Taiwan and South Korea have a combined market share over 70%. North America, Europe and Japan, have a combined market share of 23%. The key drivers are high performance computing, AI, cloud computing, Servers, 5G and EV (electric vehicle), etc.

The Global Info Research report includes an overview of the development of the Semiconductor Assembly & Packaging Equipment industry chain, the market status of IDMs (Die Bonders, Wire Bonders), OSAT (Die Bonders, Wire Bonders), and key enterprises in developed and developing market, and analysed the cutting-edge technology, patent, hot applications and market trends of Semiconductor Assembly & Packaging Equipment.

Regionally, the report analyzes the Semiconductor Assembly & Packaging Equipment

markets in key regions. North America and Europe are experiencing steady growth, driven by government initiatives and increasing consumer awareness. Asia-Pacific, particularly China, leads the global Semiconductor Assembly & Packaging Equipment market, with robust domestic demand, supportive policies, and a strong manufacturing base.

Key Features:

The report presents comprehensive understanding of the Semiconductor Assembly & Packaging Equipment market. It provides a holistic view of the industry, as well as detailed insights into individual components and stakeholders. The report analysis market dynamics, trends, challenges, and opportunities within the Semiconductor Assembly & Packaging Equipment industry.

The report involves analyzing the market at a macro level:

Market Sizing and Segmentation: Report collect data on the overall market size, including the sales quantity (Unit), revenue generated, and market share of different by Type (e.g., Die Bonders, Wire Bonders).

Industry Analysis: Report analyse the broader industry trends, such as government policies and regulations, technological advancements, consumer preferences, and market dynamics. This analysis helps in understanding the key drivers and challenges influencing the Semiconductor Assembly & Packaging Equipment market.

Regional Analysis: The report involves examining the Semiconductor Assembly & Packaging Equipment market at a regional or national level. Report analyses regional factors such as government incentives, infrastructure development, economic conditions, and consumer behaviour to identify variations and opportunities within different markets.

Market Projections: Report covers the gathered data and analysis to make future projections and forecasts for the Semiconductor Assembly & Packaging Equipment market. This may include estimating market growth rates, predicting market demand, and identifying emerging trends.

The report also involves a more granular approach to Semiconductor Assembly & Packaging Equipment:

Company Analysis: Report covers individual Semiconductor Assembly & Packaging Equipment manufacturers, suppliers, and other relevant industry players. This analysis includes studying their financial performance, market positioning, product portfolios, partnerships, and strategies.

Consumer Analysis: Report covers data on consumer behaviour, preferences, and attitudes towards Semiconductor Assembly & Packaging Equipment. This may involve surveys, interviews, and analysis of consumer reviews and feedback from different by Application (IDMs, OSAT).

Technology Analysis: Report covers specific technologies relevant to Semiconductor Assembly & Packaging Equipment. It assesses the current state, advancements, and potential future developments in Semiconductor Assembly & Packaging Equipment areas.

Competitive Landscape: By analyzing individual companies, suppliers, and consumers, the report presents insights into the competitive landscape of the Semiconductor Assembly & Packaging Equipment market. This analysis helps understand market share, competitive advantages, and potential areas for differentiation among industry players.

Market Validation: The report involves validating findings and projections through primary research, such as surveys, interviews, and focus groups.

Market Segmentation

Semiconductor Assembly & Packaging Equipment market is split by Type and by Application. For the period 2019-2030, the growth among segments provides accurate calculations and forecasts for consumption value by Type, and by Application in terms of volume and value.

Market segment by Type

Die Bonders

Wire Bonders

Packaging Equipment

Others

Market segment by Application

IDMs

OSAT

Major players covered

ASM Pacific Technology

Kulicke & Soffa Industries

Besi

Accrutech

Shinkawa

Palomar Technologies

Hesse Mechatronics

Toray Engineering

West Bond

HYBOND

DIAS Automation

Market segment by region, regional analysis covers

North America (United States, Canada and Mexico)

Europe (Germany, France, United Kingdom, Russia, Italy, and Rest of Europe)

Asia-Pacific (China, Japan, Korea, India, Southeast Asia, and Australia)

South America (Brazil, Argentina, Colombia, and Rest of South America)

Middle East & Africa (Saudi Arabia, UAE, Egypt, South Africa, and Rest of Middle East & Africa)

The content of the study subjects, includes a total of 15 chapters:

Chapter 1, to describe Semiconductor Assembly & Packaging Equipment product scope, market overview, market estimation caveats and base year.

Chapter 2, to profile the top manufacturers of Semiconductor Assembly & Packaging Equipment, with price, sales, revenue and global market share of Semiconductor Assembly & Packaging Equipment from 2019 to 2024.

Chapter 3, the Semiconductor Assembly & Packaging Equipment competitive situation, sales quantity, revenue and global market share of top manufacturers are analyzed emphatically by landscape contrast.

Chapter 4, the Semiconductor Assembly & Packaging Equipment breakdown data are shown at the regional level, to show the sales quantity, consumption value and growth by regions, from 2019 to 2030.

Chapter 5 and 6, to segment the sales by Type and application, with sales market share and growth rate by type, application, from 2019 to 2030.

Chapter 7, 8, 9, 10 and 11, to break the sales data at the country level, with sales quantity, consumption value and market share for key countries in the world, from 2017 to 2023. and Semiconductor Assembly & Packaging Equipment market forecast, by regions, type and application, with sales and revenue, from 2025 to 2030.

Chapter 12, market dynamics, drivers, restraints, trends and Porters Five Forces analysis.

Chapter 13, the key raw materials and key suppliers, and industry chain of

Semiconductor Assembly & Packaging Equipment.

Chapter 14 and 15, to describe Semiconductor Assembly & Packaging Equipment sales channel, distributors, customers, research findings and conclusion.

Contents

1 MARKET OVERVIEW

1.1 Product Overview and Scope of Semiconductor Assembly & Packaging Equipment

1.2 Market Estimation Caveats and Base Year

1.3 Market Analysis by Type

1.3.1 Overview: Global Semiconductor Assembly & Packaging Equipment

Consumption Value by Type: 2019 Versus 2023 Versus 2030

1.3.2 Die Bonders

1.3.3 Wire Bonders

1.3.4 Packaging Equipment

1.3.5 Others

1.4 Market Analysis by Application

1.4.1 Overview: Global Semiconductor Assembly & Packaging Equipment

Consumption Value by Application: 2019 Versus 2023 Versus 2030

1.4.2 IDMs

1.4.3 OSAT

1.5 Global Semiconductor Assembly & Packaging Equipment Market Size & Forecast

1.5.1 Global Semiconductor Assembly & Packaging Equipment Consumption Value (2019 & 2023 & 2030)

1.5.2 Global Semiconductor Assembly & Packaging Equipment Sales Quantity (2019-2030)

1.5.3 Global Semiconductor Assembly & Packaging Equipment Average Price (2019-2030)

2 MANUFACTURERS PROFILES

2.1 ASM Pacific Technology

2.1.1 ASM Pacific Technology Details

2.1.2 ASM Pacific Technology Major Business

2.1.3 ASM Pacific Technology Semiconductor Assembly & Packaging Equipment Product and Services

2.1.4 ASM Pacific Technology Semiconductor Assembly & Packaging Equipment Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2019-2024)

2.1.5 ASM Pacific Technology Recent Developments/Updates

2.2 Kulicke & Soffa Industries

2.2.1 Kulicke & Soffa Industries Details

2.2.2 Kulicke & Soffa Industries Major Business

2.2.3 Kulicke & Soffa Industries Semiconductor Assembly & Packaging Equipment Product and Services

2.2.4 Kulicke & Soffa Industries Semiconductor Assembly & Packaging Equipment Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2019-2024)

2.2.5 Kulicke & Soffa Industries Recent Developments/Updates

2.3 Besi

2.3.1 Besi Details

2.3.2 Besi Major Business

2.3.3 Besi Semiconductor Assembly & Packaging Equipment Product and Services

2.3.4 Besi Semiconductor Assembly & Packaging Equipment Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2019-2024)

2.3.5 Besi Recent Developments/Updates

2.4 Accrutech

2.4.1 Accrutech Details

2.4.2 Accrutech Major Business

2.4.3 Accrutech Semiconductor Assembly & Packaging Equipment Product and Services

2.4.4 Accrutech Semiconductor Assembly & Packaging Equipment Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2019-2024)

2.4.5 Accrutech Recent Developments/Updates

2.5 Shinkawa

2.5.1 Shinkawa Details

2.5.2 Shinkawa Major Business

2.5.3 Shinkawa Semiconductor Assembly & Packaging Equipment Product and Services

2.5.4 Shinkawa Semiconductor Assembly & Packaging Equipment Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2019-2024)

2.5.5 Shinkawa Recent Developments/Updates

2.6 Palomar Technologies

2.6.1 Palomar Technologies Details

2.6.2 Palomar Technologies Major Business

2.6.3 Palomar Technologies Semiconductor Assembly & Packaging Equipment Product and Services

2.6.4 Palomar Technologies Semiconductor Assembly & Packaging Equipment Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2019-2024)

2.6.5 Palomar Technologies Recent Developments/Updates

2.7 Hesse Mechatronics

2.7.1 Hesse Mechatronics Details

2.7.2 Hesse Mechatronics Major Business

2.7.3 Hesse Mechatronics Semiconductor Assembly & Packaging Equipment Product and Services

2.7.4 Hesse Mechatronics Semiconductor Assembly & Packaging Equipment Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2019-2024)

2.7.5 Hesse Mechatronics Recent Developments/Updates

2.8 Toray Engineering

2.8.1 Toray Engineering Details

2.8.2 Toray Engineering Major Business

2.8.3 Toray Engineering Semiconductor Assembly & Packaging Equipment Product and Services

2.8.4 Toray Engineering Semiconductor Assembly & Packaging Equipment Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2019-2024)

2.8.5 Toray Engineering Recent Developments/Updates

2.9 West Bond

2.9.1 West Bond Details

2.9.2 West Bond Major Business

2.9.3 West Bond Semiconductor Assembly & Packaging Equipment Product and Services

2.9.4 West Bond Semiconductor Assembly & Packaging Equipment Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2019-2024)

2.9.5 West Bond Recent Developments/Updates

2.10 HYBOND

2.10.1 HYBOND Details

2.10.2 HYBOND Major Business

2.10.3 HYBOND Semiconductor Assembly & Packaging Equipment Product and Services

2.10.4 HYBOND Semiconductor Assembly & Packaging Equipment Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2019-2024)

2.10.5 HYBOND Recent Developments/Updates

2.11 DIAS Automation

2.11.1 DIAS Automation Details

2.11.2 DIAS Automation Major Business

2.11.3 DIAS Automation Semiconductor Assembly & Packaging Equipment Product and Services

2.11.4 DIAS Automation Semiconductor Assembly & Packaging Equipment Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2019-2024)

2.11.5 DIAS Automation Recent Developments/Updates

3 COMPETITIVE ENVIRONMENT: SEMICONDUCTOR ASSEMBLY & PACKAGING

EQUIPMENT BY MANUFACTURER

- 3.1 Global Semiconductor Assembly & Packaging Equipment Sales Quantity by Manufacturer (2019-2024)
- 3.2 Global Semiconductor Assembly & Packaging Equipment Revenue by Manufacturer (2019-2024)
- 3.3 Global Semiconductor Assembly & Packaging Equipment Average Price by Manufacturer (2019-2024)
- 3.4 Market Share Analysis (2023)
 - 3.4.1 Producer Shipments of Semiconductor Assembly & Packaging Equipment by Manufacturer Revenue (\$MM) and Market Share (%): 2023
 - 3.4.2 Top 3 Semiconductor Assembly & Packaging Equipment Manufacturer Market Share in 2023
 - 3.4.2 Top 6 Semiconductor Assembly & Packaging Equipment Manufacturer Market Share in 2023
- 3.5 Semiconductor Assembly & Packaging Equipment Market: Overall Company Footprint Analysis
 - 3.5.1 Semiconductor Assembly & Packaging Equipment Market: Region Footprint
 - 3.5.2 Semiconductor Assembly & Packaging Equipment Market: Company Product Type Footprint
 - 3.5.3 Semiconductor Assembly & Packaging Equipment Market: Company Product Application Footprint
- 3.6 New Market Entrants and Barriers to Market Entry
- 3.7 Mergers, Acquisition, Agreements, and Collaborations

4 CONSUMPTION ANALYSIS BY REGION

- 4.1 Global Semiconductor Assembly & Packaging Equipment Market Size by Region
 - 4.1.1 Global Semiconductor Assembly & Packaging Equipment Sales Quantity by Region (2019-2030)
 - 4.1.2 Global Semiconductor Assembly & Packaging Equipment Consumption Value by Region (2019-2030)
 - 4.1.3 Global Semiconductor Assembly & Packaging Equipment Average Price by Region (2019-2030)
- 4.2 North America Semiconductor Assembly & Packaging Equipment Consumption Value (2019-2030)
- 4.3 Europe Semiconductor Assembly & Packaging Equipment Consumption Value (2019-2030)
- 4.4 Asia-Pacific Semiconductor Assembly & Packaging Equipment Consumption Value

(2019-2030)

4.5 South America Semiconductor Assembly & Packaging Equipment Consumption Value (2019-2030)

4.6 Middle East and Africa Semiconductor Assembly & Packaging Equipment Consumption Value (2019-2030)

5 MARKET SEGMENT BY TYPE

5.1 Global Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2019-2030)

5.2 Global Semiconductor Assembly & Packaging Equipment Consumption Value by Type (2019-2030)

5.3 Global Semiconductor Assembly & Packaging Equipment Average Price by Type (2019-2030)

6 MARKET SEGMENT BY APPLICATION

6.1 Global Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2019-2030)

6.2 Global Semiconductor Assembly & Packaging Equipment Consumption Value by Application (2019-2030)

6.3 Global Semiconductor Assembly & Packaging Equipment Average Price by Application (2019-2030)

7 NORTH AMERICA

7.1 North America Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2019-2030)

7.2 North America Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2019-2030)

7.3 North America Semiconductor Assembly & Packaging Equipment Market Size by Country

7.3.1 North America Semiconductor Assembly & Packaging Equipment Sales Quantity by Country (2019-2030)

7.3.2 North America Semiconductor Assembly & Packaging Equipment Consumption Value by Country (2019-2030)

7.3.3 United States Market Size and Forecast (2019-2030)

7.3.4 Canada Market Size and Forecast (2019-2030)

7.3.5 Mexico Market Size and Forecast (2019-2030)

8 EUROPE

8.1 Europe Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2019-2030)

8.2 Europe Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2019-2030)

8.3 Europe Semiconductor Assembly & Packaging Equipment Market Size by Country

8.3.1 Europe Semiconductor Assembly & Packaging Equipment Sales Quantity by Country (2019-2030)

8.3.2 Europe Semiconductor Assembly & Packaging Equipment Consumption Value by Country (2019-2030)

8.3.3 Germany Market Size and Forecast (2019-2030)

8.3.4 France Market Size and Forecast (2019-2030)

8.3.5 United Kingdom Market Size and Forecast (2019-2030)

8.3.6 Russia Market Size and Forecast (2019-2030)

8.3.7 Italy Market Size and Forecast (2019-2030)

9 ASIA-PACIFIC

9.1 Asia-Pacific Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2019-2030)

9.2 Asia-Pacific Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2019-2030)

9.3 Asia-Pacific Semiconductor Assembly & Packaging Equipment Market Size by Region

9.3.1 Asia-Pacific Semiconductor Assembly & Packaging Equipment Sales Quantity by Region (2019-2030)

9.3.2 Asia-Pacific Semiconductor Assembly & Packaging Equipment Consumption Value by Region (2019-2030)

9.3.3 China Market Size and Forecast (2019-2030)

9.3.4 Japan Market Size and Forecast (2019-2030)

9.3.5 Korea Market Size and Forecast (2019-2030)

9.3.6 India Market Size and Forecast (2019-2030)

9.3.7 Southeast Asia Market Size and Forecast (2019-2030)

9.3.8 Australia Market Size and Forecast (2019-2030)

10 SOUTH AMERICA

10.1 South America Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2019-2030)

10.2 South America Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2019-2030)

10.3 South America Semiconductor Assembly & Packaging Equipment Market Size by Country

10.3.1 South America Semiconductor Assembly & Packaging Equipment Sales Quantity by Country (2019-2030)

10.3.2 South America Semiconductor Assembly & Packaging Equipment Consumption Value by Country (2019-2030)

10.3.3 Brazil Market Size and Forecast (2019-2030)

10.3.4 Argentina Market Size and Forecast (2019-2030)

11 MIDDLE EAST & AFRICA

11.1 Middle East & Africa Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2019-2030)

11.2 Middle East & Africa Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2019-2030)

11.3 Middle East & Africa Semiconductor Assembly & Packaging Equipment Market Size by Country

11.3.1 Middle East & Africa Semiconductor Assembly & Packaging Equipment Sales Quantity by Country (2019-2030)

11.3.2 Middle East & Africa Semiconductor Assembly & Packaging Equipment Consumption Value by Country (2019-2030)

11.3.3 Turkey Market Size and Forecast (2019-2030)

11.3.4 Egypt Market Size and Forecast (2019-2030)

11.3.5 Saudi Arabia Market Size and Forecast (2019-2030)

11.3.6 South Africa Market Size and Forecast (2019-2030)

12 MARKET DYNAMICS

12.1 Semiconductor Assembly & Packaging Equipment Market Drivers

12.2 Semiconductor Assembly & Packaging Equipment Market Restraints

12.3 Semiconductor Assembly & Packaging Equipment Trends Analysis

12.4 Porters Five Forces Analysis

12.4.1 Threat of New Entrants

12.4.2 Bargaining Power of Suppliers

12.4.3 Bargaining Power of Buyers

12.4.4 Threat of Substitutes

12.4.5 Competitive Rivalry

13 RAW MATERIAL AND INDUSTRY CHAIN

13.1 Raw Material of Semiconductor Assembly & Packaging Equipment and Key Manufacturers

13.2 Manufacturing Costs Percentage of Semiconductor Assembly & Packaging Equipment

13.3 Semiconductor Assembly & Packaging Equipment Production Process

13.4 Semiconductor Assembly & Packaging Equipment Industrial Chain

14 SHIPMENTS BY DISTRIBUTION CHANNEL

14.1 Sales Channel

14.1.1 Direct to End-User

14.1.2 Distributors

14.2 Semiconductor Assembly & Packaging Equipment Typical Distributors

14.3 Semiconductor Assembly & Packaging Equipment Typical Customers

15 RESEARCH FINDINGS AND CONCLUSION

16 APPENDIX

16.1 Methodology

16.2 Research Process and Data Source

16.3 Disclaimer

List Of Tables

LIST OF TABLES

- Table 1. Global Semiconductor Assembly & Packaging Equipment Consumption Value by Type, (USD Million), 2019 & 2023 & 2030
- Table 2. Global Semiconductor Assembly & Packaging Equipment Consumption Value by Application, (USD Million), 2019 & 2023 & 2030
- Table 3. ASM Pacific Technology Basic Information, Manufacturing Base and Competitors
- Table 4. ASM Pacific Technology Major Business
- Table 5. ASM Pacific Technology Semiconductor Assembly & Packaging Equipment Product and Services
- Table 6. ASM Pacific Technology Semiconductor Assembly & Packaging Equipment Sales Quantity (Unit), Average Price (K USD/Unit), Revenue (USD Million), Gross Margin and Market Share (2019-2024)
- Table 7. ASM Pacific Technology Recent Developments/Updates
- Table 8. Kulicke & Soffa Industries Basic Information, Manufacturing Base and Competitors
- Table 9. Kulicke & Soffa Industries Major Business
- Table 10. Kulicke & Soffa Industries Semiconductor Assembly & Packaging Equipment Product and Services
- Table 11. Kulicke & Soffa Industries Semiconductor Assembly & Packaging Equipment Sales Quantity (Unit), Average Price (K USD/Unit), Revenue (USD Million), Gross Margin and Market Share (2019-2024)
- Table 12. Kulicke & Soffa Industries Recent Developments/Updates
- Table 13. Besi Basic Information, Manufacturing Base and Competitors
- Table 14. Besi Major Business
- Table 15. Besi Semiconductor Assembly & Packaging Equipment Product and Services
- Table 16. Besi Semiconductor Assembly & Packaging Equipment Sales Quantity (Unit), Average Price (K USD/Unit), Revenue (USD Million), Gross Margin and Market Share (2019-2024)
- Table 17. Besi Recent Developments/Updates
- Table 18. Accrutech Basic Information, Manufacturing Base and Competitors
- Table 19. Accrutech Major Business
- Table 20. Accrutech Semiconductor Assembly & Packaging Equipment Product and Services
- Table 21. Accrutech Semiconductor Assembly & Packaging Equipment Sales Quantity (Unit), Average Price (K USD/Unit), Revenue (USD Million), Gross Margin and Market

Share (2019-2024)

Table 22. Accrutech Recent Developments/Updates

Table 23. Shinkawa Basic Information, Manufacturing Base and Competitors

Table 24. Shinkawa Major Business

Table 25. Shinkawa Semiconductor Assembly & Packaging Equipment Product and Services

Table 26. Shinkawa Semiconductor Assembly & Packaging Equipment Sales Quantity (Unit), Average Price (K USD/Unit), Revenue (USD Million), Gross Margin and Market Share (2019-2024)

Table 27. Shinkawa Recent Developments/Updates

Table 28. Palomar Technologies Basic Information, Manufacturing Base and Competitors

Table 29. Palomar Technologies Major Business

Table 30. Palomar Technologies Semiconductor Assembly & Packaging Equipment Product and Services

Table 31. Palomar Technologies Semiconductor Assembly & Packaging Equipment Sales Quantity (Unit), Average Price (K USD/Unit), Revenue (USD Million), Gross Margin and Market Share (2019-2024)

Table 32. Palomar Technologies Recent Developments/Updates

Table 33. Hesse Mechatronics Basic Information, Manufacturing Base and Competitors

Table 34. Hesse Mechatronics Major Business

Table 35. Hesse Mechatronics Semiconductor Assembly & Packaging Equipment Product and Services

Table 36. Hesse Mechatronics Semiconductor Assembly & Packaging Equipment Sales Quantity (Unit), Average Price (K USD/Unit), Revenue (USD Million), Gross Margin and Market Share (2019-2024)

Table 37. Hesse Mechatronics Recent Developments/Updates

Table 38. Toray Engineering Basic Information, Manufacturing Base and Competitors

Table 39. Toray Engineering Major Business

Table 40. Toray Engineering Semiconductor Assembly & Packaging Equipment Product and Services

Table 41. Toray Engineering Semiconductor Assembly & Packaging Equipment Sales Quantity (Unit), Average Price (K USD/Unit), Revenue (USD Million), Gross Margin and Market Share (2019-2024)

Table 42. Toray Engineering Recent Developments/Updates

Table 43. West Bond Basic Information, Manufacturing Base and Competitors

Table 44. West Bond Major Business

Table 45. West Bond Semiconductor Assembly & Packaging Equipment Product and Services

Table 46. West Bond Semiconductor Assembly & Packaging Equipment Sales Quantity (Unit), Average Price (K USD/Unit), Revenue (USD Million), Gross Margin and Market Share (2019-2024)

Table 47. West Bond Recent Developments/Updates

Table 48. HYBOND Basic Information, Manufacturing Base and Competitors

Table 49. HYBOND Major Business

Table 50. HYBOND Semiconductor Assembly & Packaging Equipment Product and Services

Table 51. HYBOND Semiconductor Assembly & Packaging Equipment Sales Quantity (Unit), Average Price (K USD/Unit), Revenue (USD Million), Gross Margin and Market Share (2019-2024)

Table 52. HYBOND Recent Developments/Updates

Table 53. DIAS Automation Basic Information, Manufacturing Base and Competitors

Table 54. DIAS Automation Major Business

Table 55. DIAS Automation Semiconductor Assembly & Packaging Equipment Product and Services

Table 56. DIAS Automation Semiconductor Assembly & Packaging Equipment Sales Quantity (Unit), Average Price (K USD/Unit), Revenue (USD Million), Gross Margin and Market Share (2019-2024)

Table 57. DIAS Automation Recent Developments/Updates

Table 58. Global Semiconductor Assembly & Packaging Equipment Sales Quantity by Manufacturer (2019-2024) & (Unit)

Table 59. Global Semiconductor Assembly & Packaging Equipment Revenue by Manufacturer (2019-2024) & (USD Million)

Table 60. Global Semiconductor Assembly & Packaging Equipment Average Price by Manufacturer (2019-2024) & (K USD/Unit)

Table 61. Market Position of Manufacturers in Semiconductor Assembly & Packaging Equipment, (Tier 1, Tier 2, and Tier 3), Based on Consumption Value in 2023

Table 62. Head Office and Semiconductor Assembly & Packaging Equipment Production Site of Key Manufacturer

Table 63. Semiconductor Assembly & Packaging Equipment Market: Company Product Type Footprint

Table 64. Semiconductor Assembly & Packaging Equipment Market: Company Product Application Footprint

Table 65. Semiconductor Assembly & Packaging Equipment New Market Entrants and Barriers to Market Entry

Table 66. Semiconductor Assembly & Packaging Equipment Mergers, Acquisition, Agreements, and Collaborations

Table 67. Global Semiconductor Assembly & Packaging Equipment Sales Quantity by

Region (2019-2024) & (Unit)

Table 68. Global Semiconductor Assembly & Packaging Equipment Sales Quantity by Region (2025-2030) & (Unit)

Table 69. Global Semiconductor Assembly & Packaging Equipment Consumption Value by Region (2019-2024) & (USD Million)

Table 70. Global Semiconductor Assembly & Packaging Equipment Consumption Value by Region (2025-2030) & (USD Million)

Table 71. Global Semiconductor Assembly & Packaging Equipment Average Price by Region (2019-2024) & (K USD/Unit)

Table 72. Global Semiconductor Assembly & Packaging Equipment Average Price by Region (2025-2030) & (K USD/Unit)

Table 73. Global Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2019-2024) & (Unit)

Table 74. Global Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2025-2030) & (Unit)

Table 75. Global Semiconductor Assembly & Packaging Equipment Consumption Value by Type (2019-2024) & (USD Million)

Table 76. Global Semiconductor Assembly & Packaging Equipment Consumption Value by Type (2025-2030) & (USD Million)

Table 77. Global Semiconductor Assembly & Packaging Equipment Average Price by Type (2019-2024) & (K USD/Unit)

Table 78. Global Semiconductor Assembly & Packaging Equipment Average Price by Type (2025-2030) & (K USD/Unit)

Table 79. Global Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2019-2024) & (Unit)

Table 80. Global Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2025-2030) & (Unit)

Table 81. Global Semiconductor Assembly & Packaging Equipment Consumption Value by Application (2019-2024) & (USD Million)

Table 82. Global Semiconductor Assembly & Packaging Equipment Consumption Value by Application (2025-2030) & (USD Million)

Table 83. Global Semiconductor Assembly & Packaging Equipment Average Price by Application (2019-2024) & (K USD/Unit)

Table 84. Global Semiconductor Assembly & Packaging Equipment Average Price by Application (2025-2030) & (K USD/Unit)

Table 85. North America Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2019-2024) & (Unit)

Table 86. North America Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2025-2030) & (Unit)

- Table 87. North America Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2019-2024) & (Unit)
- Table 88. North America Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2025-2030) & (Unit)
- Table 89. North America Semiconductor Assembly & Packaging Equipment Sales Quantity by Country (2019-2024) & (Unit)
- Table 90. North America Semiconductor Assembly & Packaging Equipment Sales Quantity by Country (2025-2030) & (Unit)
- Table 91. North America Semiconductor Assembly & Packaging Equipment Consumption Value by Country (2019-2024) & (USD Million)
- Table 92. North America Semiconductor Assembly & Packaging Equipment Consumption Value by Country (2025-2030) & (USD Million)
- Table 93. Europe Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2019-2024) & (Unit)
- Table 94. Europe Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2025-2030) & (Unit)
- Table 95. Europe Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2019-2024) & (Unit)
- Table 96. Europe Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2025-2030) & (Unit)
- Table 97. Europe Semiconductor Assembly & Packaging Equipment Sales Quantity by Country (2019-2024) & (Unit)
- Table 98. Europe Semiconductor Assembly & Packaging Equipment Sales Quantity by Country (2025-2030) & (Unit)
- Table 99. Europe Semiconductor Assembly & Packaging Equipment Consumption Value by Country (2019-2024) & (USD Million)
- Table 100. Europe Semiconductor Assembly & Packaging Equipment Consumption Value by Country (2025-2030) & (USD Million)
- Table 101. Asia-Pacific Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2019-2024) & (Unit)
- Table 102. Asia-Pacific Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2025-2030) & (Unit)
- Table 103. Asia-Pacific Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2019-2024) & (Unit)
- Table 104. Asia-Pacific Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2025-2030) & (Unit)
- Table 105. Asia-Pacific Semiconductor Assembly & Packaging Equipment Sales Quantity by Region (2019-2024) & (Unit)
- Table 106. Asia-Pacific Semiconductor Assembly & Packaging Equipment Sales

Quantity by Region (2025-2030) & (Unit)

Table 107. Asia-Pacific Semiconductor Assembly & Packaging Equipment Consumption Value by Region (2019-2024) & (USD Million)

Table 108. Asia-Pacific Semiconductor Assembly & Packaging Equipment Consumption Value by Region (2025-2030) & (USD Million)

Table 109. South America Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2019-2024) & (Unit)

Table 110. South America Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2025-2030) & (Unit)

Table 111. South America Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2019-2024) & (Unit)

Table 112. South America Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2025-2030) & (Unit)

Table 113. South America Semiconductor Assembly & Packaging Equipment Sales Quantity by Country (2019-2024) & (Unit)

Table 114. South America Semiconductor Assembly & Packaging Equipment Sales Quantity by Country (2025-2030) & (Unit)

Table 115. South America Semiconductor Assembly & Packaging Equipment Consumption Value by Country (2019-2024) & (USD Million)

Table 116. South America Semiconductor Assembly & Packaging Equipment Consumption Value by Country (2025-2030) & (USD Million)

Table 117. Middle East & Africa Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2019-2024) & (Unit)

Table 118. Middle East & Africa Semiconductor Assembly & Packaging Equipment Sales Quantity by Type (2025-2030) & (Unit)

Table 119. Middle East & Africa Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2019-2024) & (Unit)

Table 120. Middle East & Africa Semiconductor Assembly & Packaging Equipment Sales Quantity by Application (2025-2030) & (Unit)

Table 121. Middle East & Africa Semiconductor Assembly & Packaging Equipment Sales Quantity by Region (2019-2024) & (Unit)

Table 122. Middle East & Africa Semiconductor Assembly & Packaging Equipment Sales Quantity by Region (2025-2030) & (Unit)

Table 123. Middle East & Africa Semiconductor Assembly & Packaging Equipment Consumption Value by Region (2019-2024) & (USD Million)

Table 124. Middle East & Africa Semiconductor Assembly & Packaging Equipment Consumption Value by Region (2025-2030) & (USD Million)

Table 125. Semiconductor Assembly & Packaging Equipment Raw Material

Table 126. Key Manufacturers of Semiconductor Assembly & Packaging Equipment

Raw Materials

Table 127. Semiconductor Assembly & Packaging Equipment Typical Distributors

Table 128. Semiconductor Assembly & Packaging Equipment Typical Customers

List Of Figures

LIST OF FIGURES

- Figure 1. Semiconductor Assembly & Packaging Equipment Picture
- Figure 2. Global Semiconductor Assembly & Packaging Equipment Consumption Value by Type, (USD Million), 2019 & 2023 & 2030
- Figure 3. Global Semiconductor Assembly & Packaging Equipment Consumption Value Market Share by Type in 2023
- Figure 4. Die Bonders Examples
- Figure 5. Wire Bonders Examples
- Figure 6. Packaging Equipment Examples
- Figure 7. Others Examples
- Figure 8. Global Semiconductor Assembly & Packaging Equipment Consumption Value by Application, (USD Million), 2019 & 2023 & 2030
- Figure 9. Global Semiconductor Assembly & Packaging Equipment Consumption Value Market Share by Application in 2023
- Figure 10. IDMs Examples
- Figure 11. OSAT Examples
- Figure 12. Global Semiconductor Assembly & Packaging Equipment Consumption Value, (USD Million): 2019 & 2023 & 2030
- Figure 13. Global Semiconductor Assembly & Packaging Equipment Consumption Value and Forecast (2019-2030) & (USD Million)
- Figure 14. Global Semiconductor Assembly & Packaging Equipment Sales Quantity (2019-2030) & (Unit)
- Figure 15. Global Semiconductor Assembly & Packaging Equipment Average Price (2019-2030) & (K USD/Unit)
- Figure 16. Global Semiconductor Assembly & Packaging Equipment Sales Quantity Market Share by Manufacturer in 2023
- Figure 17. Global Semiconductor Assembly & Packaging Equipment Consumption Value Market Share by Manufacturer in 2023
- Figure 18. Producer Shipments of Semiconductor Assembly & Packaging Equipment by Manufacturer Sales Quantity (\$MM) and Market Share (%): 2023
- Figure 19. Top 3 Semiconductor Assembly & Packaging Equipment Manufacturer (Consumption Value) Market Share in 2023
- Figure 20. Top 6 Semiconductor Assembly & Packaging Equipment Manufacturer (Consumption Value) Market Share in 2023
- Figure 21. Global Semiconductor Assembly & Packaging Equipment Sales Quantity Market Share by Region (2019-2030)

Figure 22. Global Semiconductor Assembly & Packaging Equipment Consumption Value Market Share by Region (2019-2030)

Figure 23. North America Semiconductor Assembly & Packaging Equipment Consumption Value (2019-2030) & (USD Million)

Figure 24. Europe Semiconductor Assembly & Packaging Equipment Consumption Value (2019-2030) & (USD Million)

Figure 25. Asia-Pacific Semiconductor Assembly & Packaging Equipment Consumption Value (2019-2030) & (USD Million)

Figure 26. South America Semiconductor Assembly & Packaging Equipment Consumption Value (2019-2030) & (USD Million)

Figure 27. Middle East & Africa Semiconductor Assembly & Packaging Equipment Consumption Value (2019-2030) & (USD Million)

Figure 28. Global Semiconductor Assembly & Packaging Equipment Sales Quantity Market Share by Type (2019-2030)

Figure 29. Global Semiconductor Assembly & Packaging Equipment Consumption Value Market Share by Type (2019-2030)

Figure 30. Global Semiconductor Assembly & Packaging Equipment Average Price by Type (2019-2030) & (K USD/Unit)

Figure 31. Global Semiconductor Assembly & Packaging Equipment Sales Quantity Market Share by Application (2019-2030)

Figure 32. Global Semiconductor Assembly & Packaging Equipment Consumption Value Market Share by Application (2019-2030)

Figure 33. Global Semiconductor Assembly & Packaging Equipment Average Price by Application (2019-2030) & (K USD/Unit)

Figure 34. North America Semiconductor Assembly & Packaging Equipment Sales Quantity Market Share by Type (2019-2030)

Figure 35. North America Semiconductor Assembly & Packaging Equipment Sales Quantity Market Share by Application (2019-2030)

Figure 36. North America Semiconductor Assembly & Packaging Equipment Sales Quantity Market Share by Country (2019-2030)

Figure 37. North America Semiconductor Assembly & Packaging Equipment Consumption Value Market Share by Country (2019-2030)

Figure 38. United States Semiconductor Assembly & Packaging Equipment Consumption Value and Growth Rate (2019-2030) & (USD Million)

Figure 39. Canada Semiconductor Assembly & Packaging Equipment Consumption Value and Growth Rate (2019-2030) & (USD Million)

Figure 40. Mexico Semiconductor Assembly & Packaging Equipment Consumption Value and Growth Rate (2019-2030) & (USD Million)

Figure 41. Europe Semiconductor Assembly & Packaging Equipment Sales Quantity

Market Share by Type (2019-2030)

Figure 42. Europe Semiconductor Assembly & Packaging Equipment Sales Quantity

Market Share by Application (2019-2030)

Figure 43. Europe Semiconductor Assembly & Packaging Equipment Sales Quantity

Market Share by Country (2019-2030)

Figure 44. Europe Semiconductor Assembly & Packaging Equipment Consumption

Value Market Share by Country (2019-2030)

Figure 45. Germany Semiconductor Assembly & Packaging Equipment Consumption

Value and Growth Rate (2019-2030) & (USD Million)

Figure 46. France Semiconductor Assembly & Packaging Equipment Consumption

Value and Growth Rate (2019-2030) & (USD Million)

Figure 47. United Kingdom Semiconductor Assembly & Packaging Equipment

Consumption Value and Growth Rate (2019-2030) & (USD Million)

Figure 48. Russia Semiconductor Assembly & Packaging Equipment Consumption

Value and Growth Rate (2019-2030) & (USD Million)

Figure 49. Italy Semiconductor Assembly & Packaging Equipment Consumption Value

and Growth Rate (2019-2030) & (USD Million)

Figure 50. Asia-Pacific Semiconductor Assembly & Packaging Equipment Sales

Quantity Market Share by Type (2019-2030)

Figure 51. Asia-Pacific Semiconductor Assembly & Packaging Equipment Sales

Quantity Market Share by Application (2019-2030)

Figure 52. Asia-Pacific Semiconductor Assembly & Packaging Equipment Sales

Quantity Market Share by Region (2019-2030)

Figure 53. Asia-Pacific Semiconductor Assembly & Packaging Equipment Consumption

Value Market Share by Region (2019-2030)

Figure 54. China Semiconductor Assembly & Packaging Equipment Consumption Value

and Growth Rate (2019-2030) & (USD Million)

Figure 55. Japan Semiconductor Assembly & Packaging Equipment Consumption

Value and Growth Rate (2019-2030) & (USD Million)

Figure 56. Korea Semiconductor Assembly & Packaging Equipment Consumption Value

and Growth Rate (2019-2030) & (USD Million)

Figure 57. India Semiconductor Assembly & Packaging Equipment Consumption Value

and Growth Rate (2019-2030) & (USD Million)

Figure 58. Southeast Asia Semiconductor Assembly & Packaging Equipment

Consumption Value and Growth Rate (2019-2030) & (USD Million)

Figure 59. Australia Semiconductor Assembly & Packaging Equipment Consumption

Value and Growth Rate (2019-2030) & (USD Million)

Figure 60. South America Semiconductor Assembly & Packaging Equipment Sales

Quantity Market Share by Type (2019-2030)

Figure 61. South America Semiconductor Assembly & Packaging Equipment Sales Quantity Market Share by Application (2019-2030)

Figure 62. South America Semiconductor Assembly & Packaging Equipment Sales Quantity Market Share by Country (2019-2030)

Figure 63. South America Semiconductor Assembly & Packaging Equipment Consumption Value Market Share by Country (2019-2030)

Figure 64. Brazil Semiconductor Assembly & Packaging Equipment Consumption Value and Growth Rate (2019-2030) & (USD Million)

Figure 65. Argentina Semiconductor Assembly & Packaging Equipment Consumption Value and Growth Rate (2019-2030) & (USD Million)

Figure 66. Middle East & Africa Semiconductor Assembly & Packaging Equipment Sales Quantity Market Share by Type (2019-2030)

Figure 67. Middle East & Africa Semiconductor Assembly & Packaging Equipment Sales Quantity Market Share by Application (2019-2030)

Figure 68. Middle East & Africa Semiconductor Assembly & Packaging Equipment Sales Quantity Market Share by Region (2019-2030)

Figure 69. Middle East & Africa Semiconductor Assembly & Packaging Equipment Consumption Value Market Share by Region (2019-2030)

Figure 70. Turkey Semiconductor Assembly & Packaging Equipment Consumption Value and Growth Rate (2019-2030) & (USD Million)

Figure 71. Egypt Semiconductor Assembly & Packaging Equipment Consumption Value and Growth Rate (2019-2030) & (USD Million)

Figure 72. Saudi Arabia Semiconductor Assembly & Packaging Equipment Consumption Value and Growth Rate (2019-2030) & (USD Million)

Figure 73. South Africa Semiconductor Assembly & Packaging Equipment Consumption Value and Growth Rate (2019-2030) & (USD Million)

Figure 74. Semiconductor Assembly & Packaging Equipment Market Drivers

Figure 75. Semiconductor Assembly & Packaging Equipment Market Restraints

Figure 76. Semiconductor Assembly & Packaging Equipment Market Trends

Figure 77. Porters Five Forces Analysis

Figure 78. Manufacturing Cost Structure Analysis of Semiconductor Assembly & Packaging Equipment in 2023

Figure 79. Manufacturing Process Analysis of Semiconductor Assembly & Packaging Equipment

Figure 80. Semiconductor Assembly & Packaging Equipment Industrial Chain

Figure 81. Sales Quantity Channel: Direct to End-User vs Distributors

Figure 82. Direct Channel Pros & Cons

Figure 83. Indirect Channel Pros & Cons

Figure 84. Methodology

Figure 85. Research Process and Data Source

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